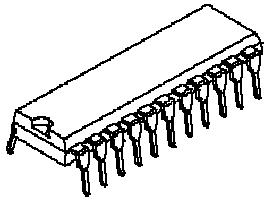
DUAL H BRIDGE DRIVER

■ GENERAL DESCRIPTION

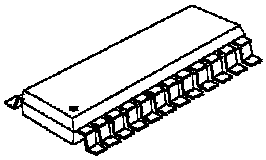
The NJM2670 is a general-purpose 60V dual H-bridge drive IC. It consists of a pair of H-bridges, a thermal shut down circuit and its alarm output. The alarm output can detect application problems and the system reliability will be significantly improved if monitored by Micro Processor.

Therefore, it is suitable for two-phase stepper motor application driven by microprocessor.

■ PACKAGE OUTLINE



NJM2670D2

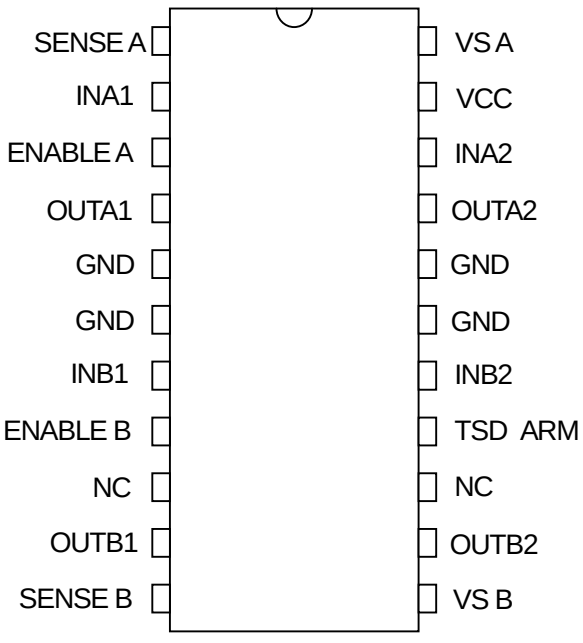


NJM2670E3

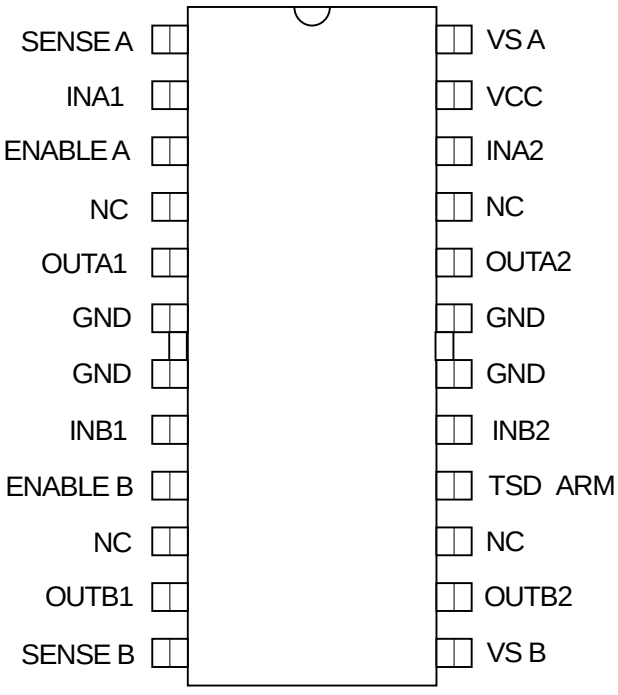
■ FEATURES

- Wide Voltage Range (4V to 60V)
- Wide Range of Current Control (5 to 1500mA)
- Thermal overload Protection
- Dead Band Protector
- Package Outline (DIP-22, EMP-24)

■ PIN CONNECTION

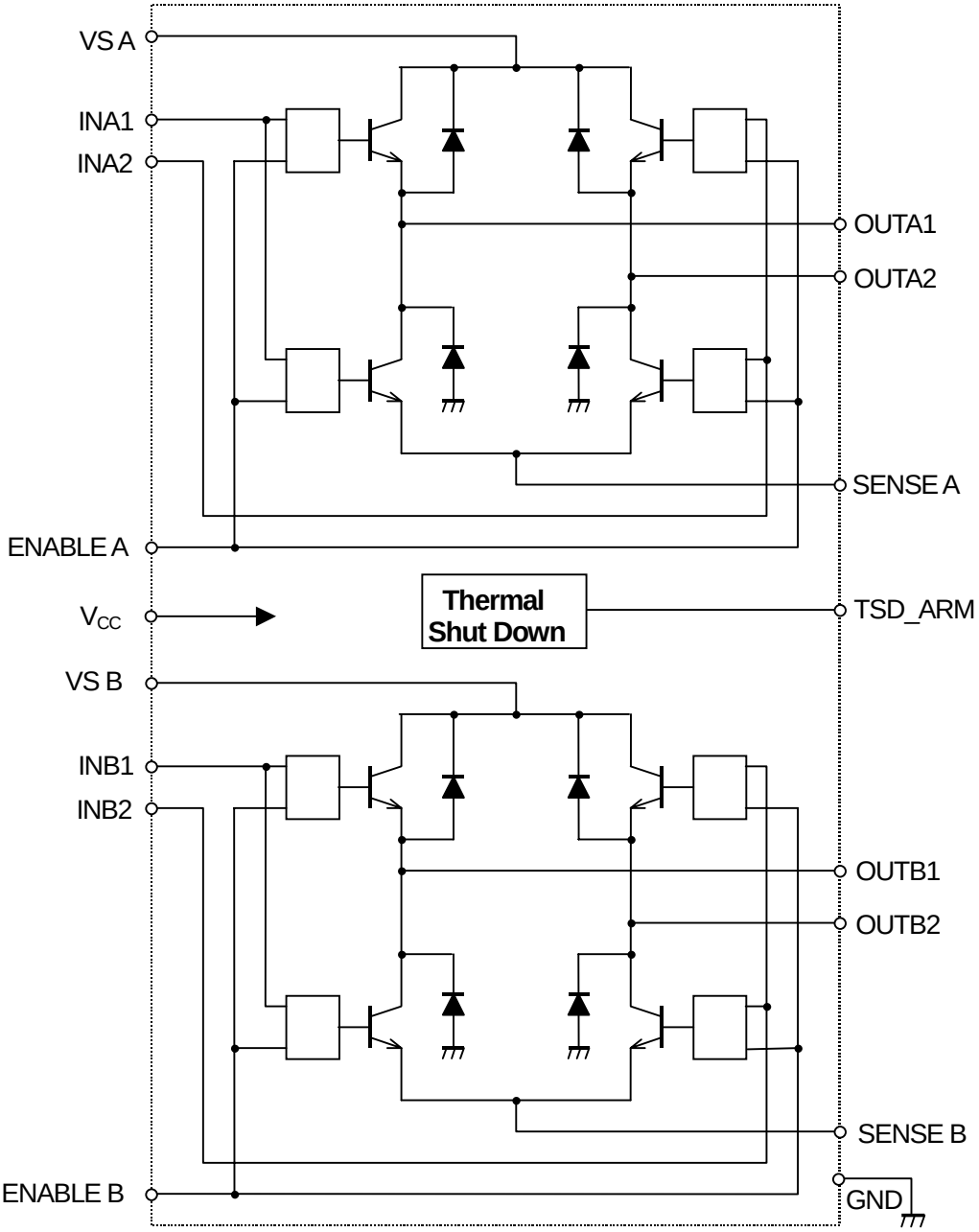


DIP-22



EMP-24

■BLOCK DIAGRAM



■ ABSOLUTE MAXIMUM RATINGS (Ta=25°C)

PARAMETER	SYMBOL	RATINGS	UNIT
Maximum Supply Voltage	V_{MM}	60	V
Logic Supply Voltage	V_{CC}	7	V
Input Voltage Range	V_{IN}	-0.3 to 7	V
Output Current	I_{OUT}	1.5	A
Power Dissipation@T(GND)=25°C	P_{D25}	5	W
Power Dissipation@T(GND)=125°C	P_{D125}	2	W
Operating Junction Temperature	Topr	-40 ~ 85	°C
Storage Temperature	Tstg	-55 ~ 150	°C

■ RECOMENNDO OPERATING CONDITIONS

PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Supply Voltage	V_{MM}		4	-	55	V
Logic Voltage Range	V_{CC}		4.75	5.00	5.25	V
Maximum Output Current	I_{OUT}		-	-	1.3	A
Total Power Dissipation	P_D	T_{GND}=25°C	-	-	5	W
	P_D	T_{GND}=125°C	-	-	2.2	W

■ THERMAL CHARACTERISTICS

PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Thermal resistance	Rth_{j-GND}	DIP22 package.	-	11	-	°C/W
	Rth_{j-A}	DIP22 package. Note	-	40	-	°C/W
	Rth_{j-GND}	EMP24 package.	-	13	-	°C/W
	Rth_{j-A}	EMP24 package. Note	-	42	-	°C/W

Note : All ground pins soldered onto a 20 cm^2 PCB copper area with free air convection, T_A=+25°C

■ELECTRICAL CHARACTERISTICS

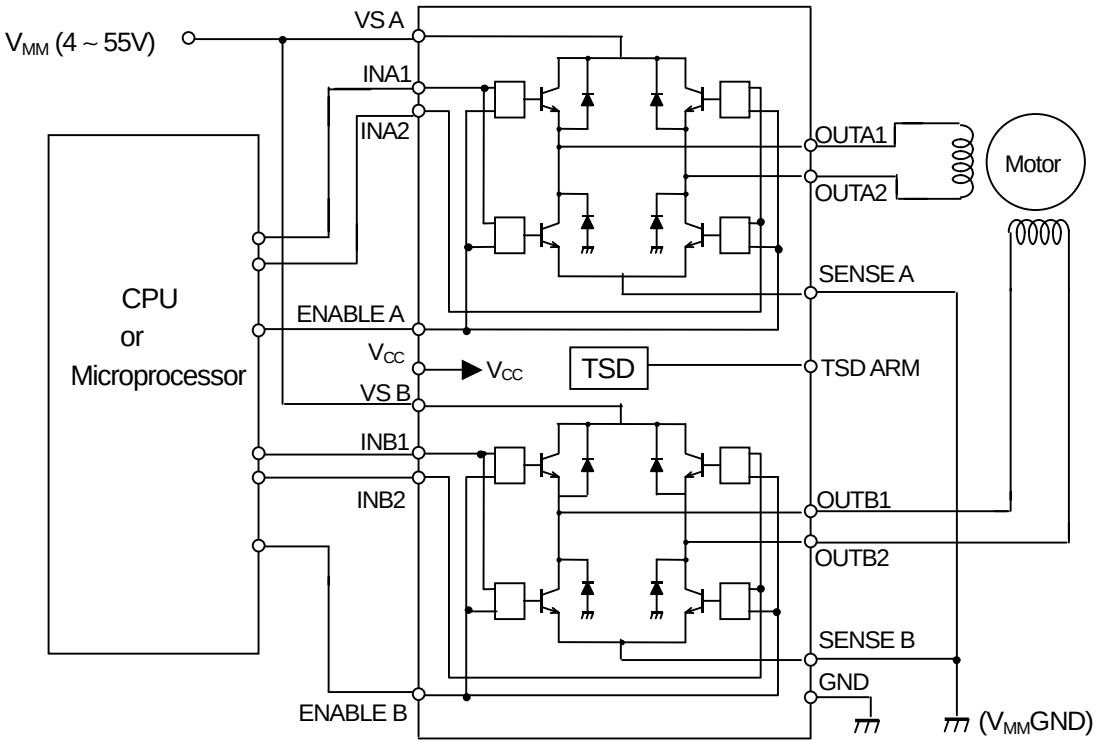
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
GENERAL						
Quiescent current	Icc	Enable=H,IN1=IN3=L,IN2=IN4=H	-	40	-	mA
Thermal shutdown	Ttsd		-	170	-	°C
Off-State leak current	$Itsd\text{-}_{LEAK}$	TSD ARM=5V	-	-	50	µA
Thermal alarm output saturation	Vtsd	Io=5mA	-	0.5	0.7	V
Dead time protection	Td		-	1	-	µs
LOGIC						
Input LOW voltage	Vi_L		-	-	0.6	V
Input HIGH voltage	Vi_H		2	-	-	V
Input HIGH current	Ii_H	Vi=2.4V	-	-	20	µA
Input LOW current	Ii_L	Vi=0.4V	-0.4	-	-	mA
OUTPUT						
Upper transistor saturation	V_{OU1}	Io=1000mA	-	1.3	1.5	V
	V_{OU2}	Io=1300mA	-	1.5	1.8	V
Lower transistor saturation	V_{OL1}	Io=1000mA	-	0.5	0.8	V
	V_{OL2}	Io=1300mA	-	0.8	1.3	V
Upper diode forward	V_{fU1}	Io=1000mA	-	1.3	1.6	V
	V_{fU2}	Io=1300mA	-	1.6	1.9	V
Lower diode forward	V_{fL1}	Io=1000mA	-	1.3	1.6	V
	V_{fL2}	Io=1300mA	-	1.6	1.9	V
Output leakage current	$Lo\text{-}_{LEAK}$	V_{MM}=50V	-	-	1	mA
Upper diode recoverly time	Trr_U		-	250	-	ns
Lower diode recoverly time	Trr_L		-	250	-	ns

■TRUTH TABLE

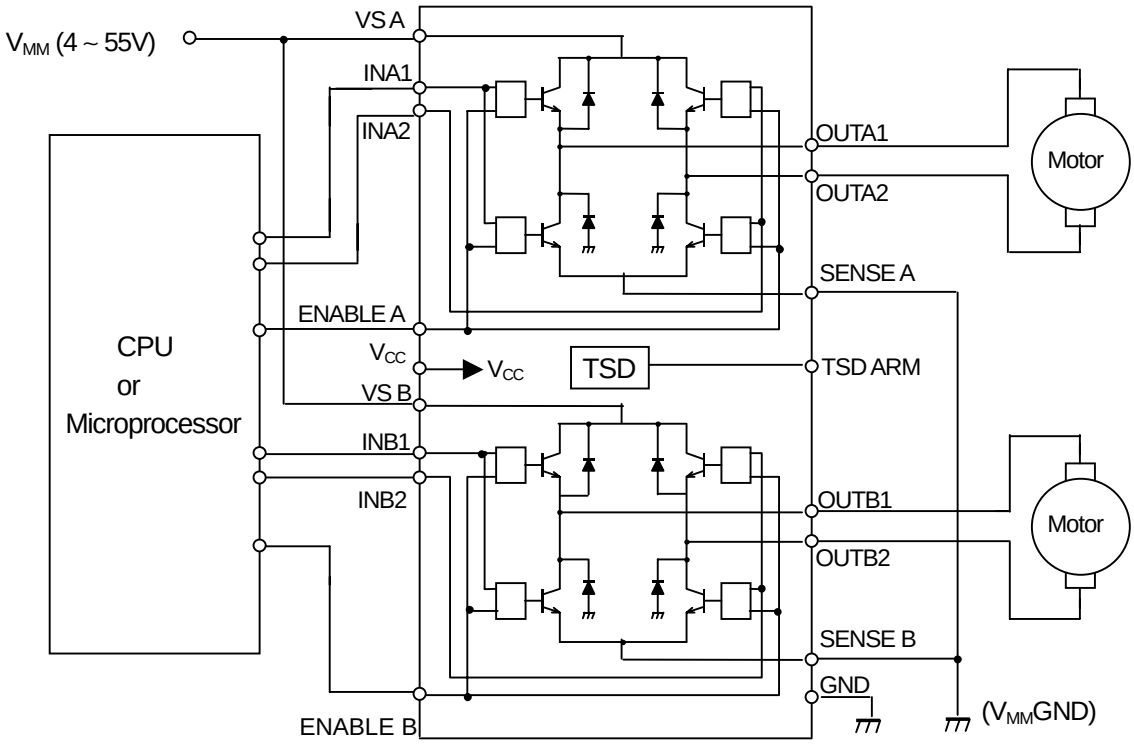
INPUT (L=Low,H=High,X=Don't care)			OUTPUT (H=Source,L=Sink)		OUTPUT mode
ENABLE A=H ENABLE B=H	INA1 INB1	INA2 INB2	OUTA1 OUTB1	OUTA2 OUTB2	
	L	L	L	L	short break mode
	L	H	L	H	CW
	H	L	H	L	CCW
	H	H	H	H	short break mode
ENABLE A=L ENABLE B=L	X	X	All Transistor turned OFF		

■TYPICAL APPLICATION

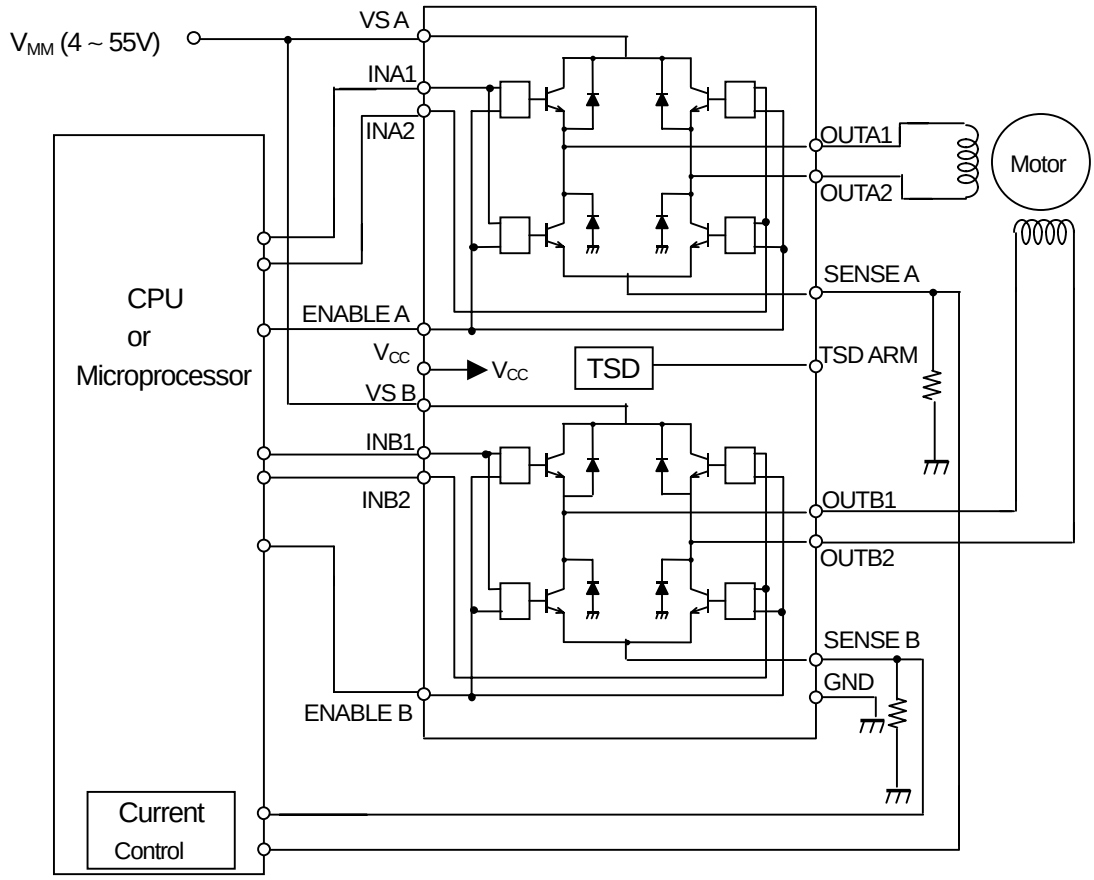
1). Bipolar Stepper Motor



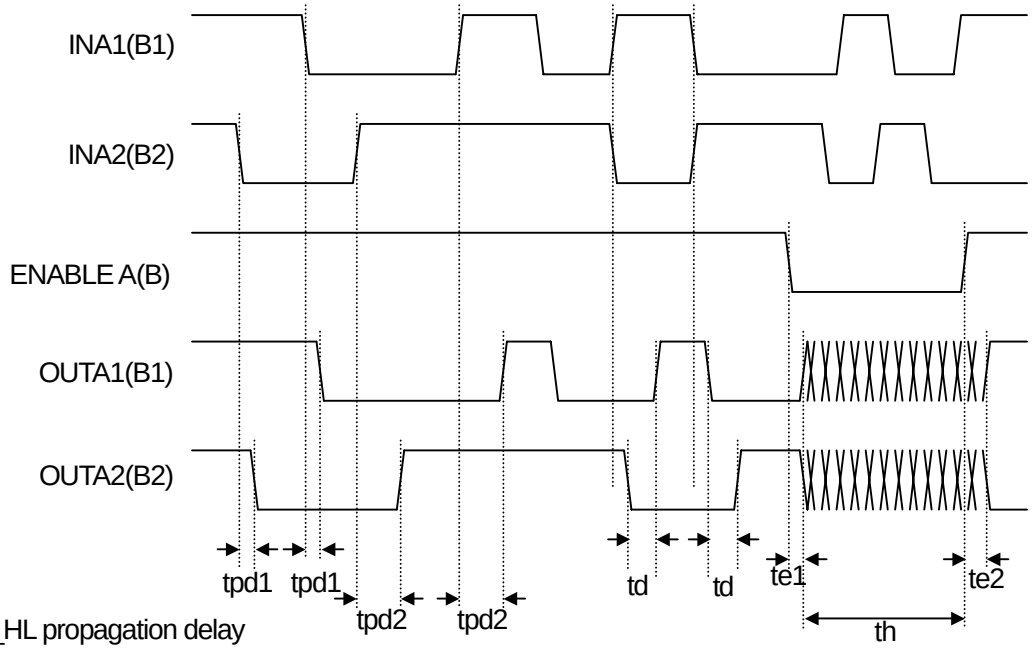
2). Single Phase DC Motor



3) Current Control Application for Bipolar Stepper Motor



■ TIMING CHART

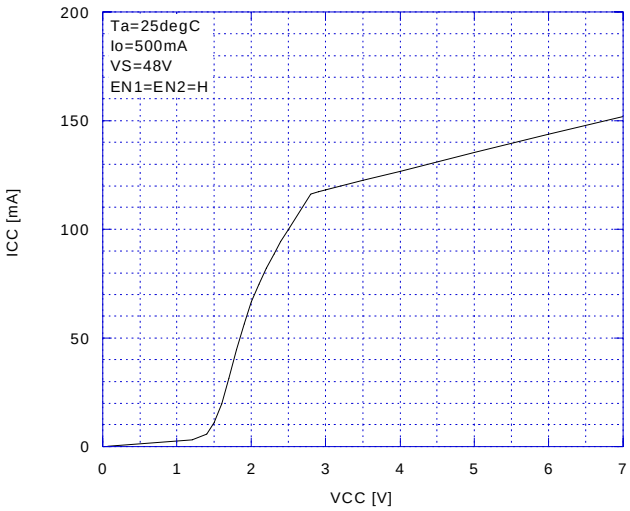


tpd1:IN_HL propagation delay
tpd2:IN_LH propagation delay
td :Output dead band protection delay
te1 :ENABLE_HL propagation delay
te2 :ENABLE_LH propagation delay
th :Output High impedance section

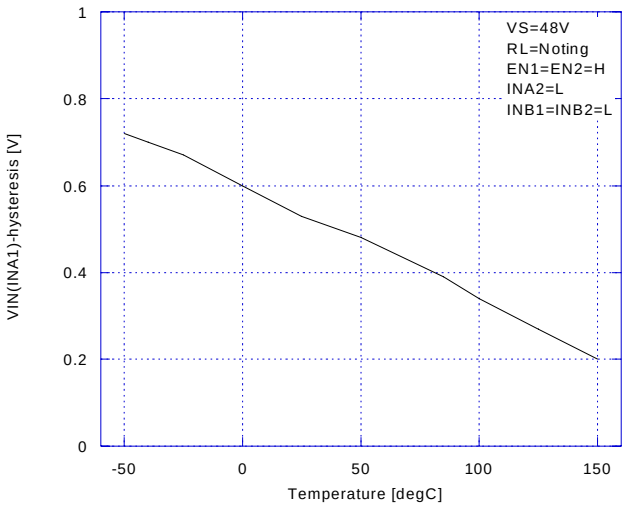
	Reference value	unit
tpd1	1.0	us
tpd2	2.5	us
td	1.5	us
te1	3.5	us
te2	2.0	us

■TYPICAL APPLICATION 1

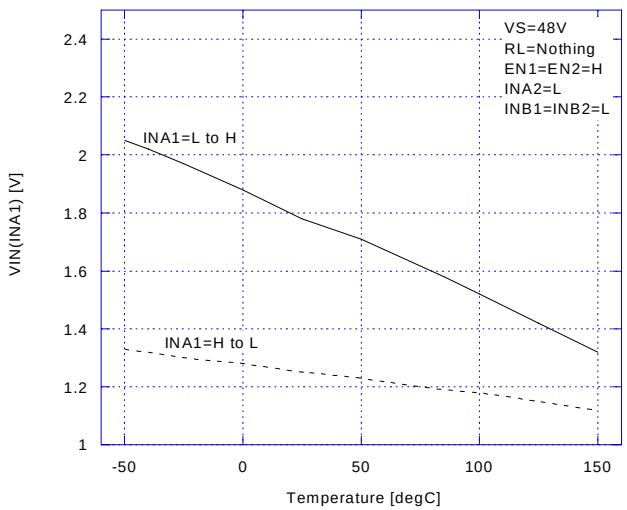
ICC vs. VCC



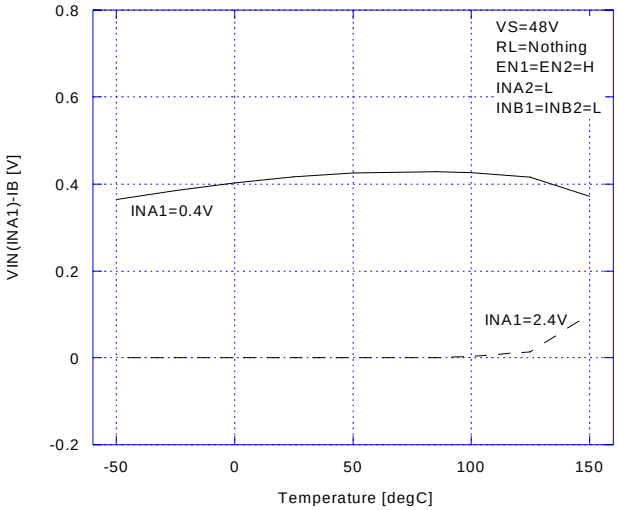
VIN(INA1)-hysteresis vs. Temperature



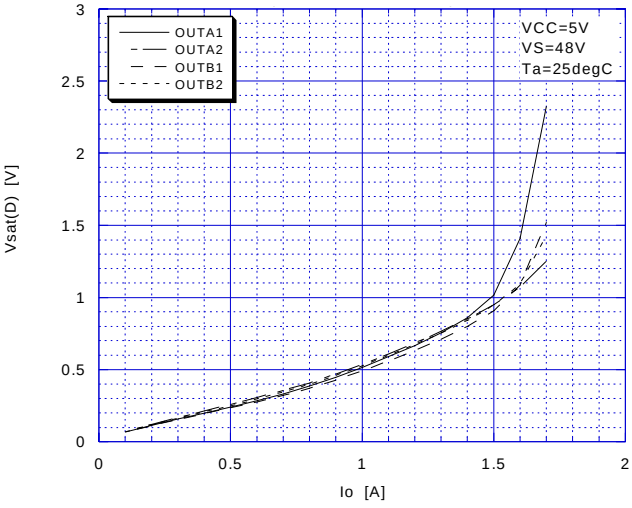
VIN(INA1) vs. Temperature



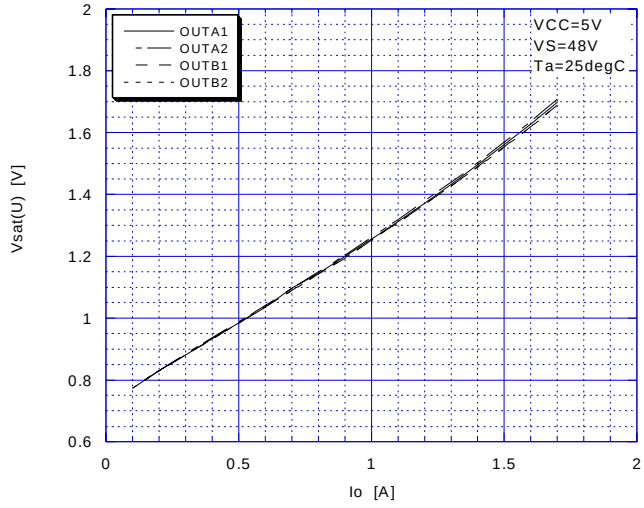
VIN(INA1)-IB vs. Temperature



Vsat(D) vs. Io

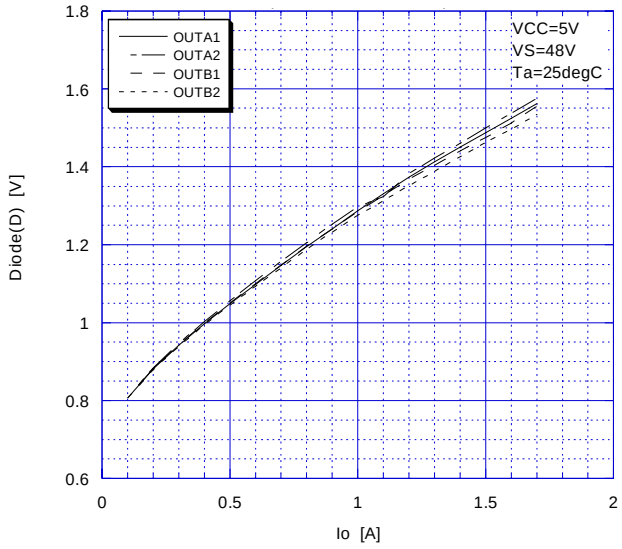


Vsat(U) vs. Io

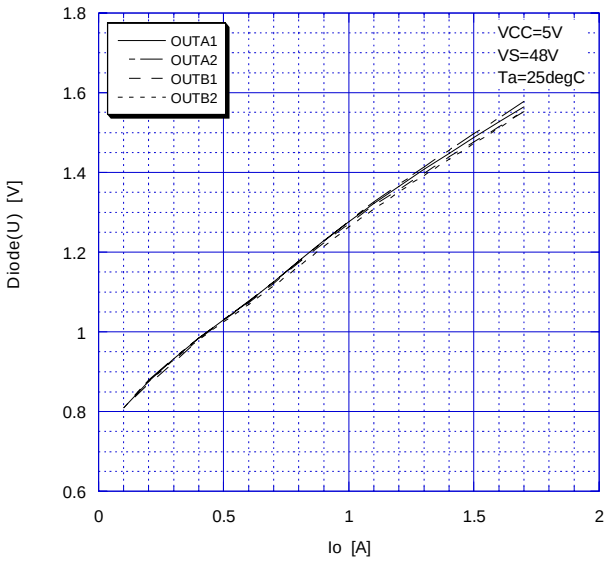


■TYPICAL APPLICATION 2

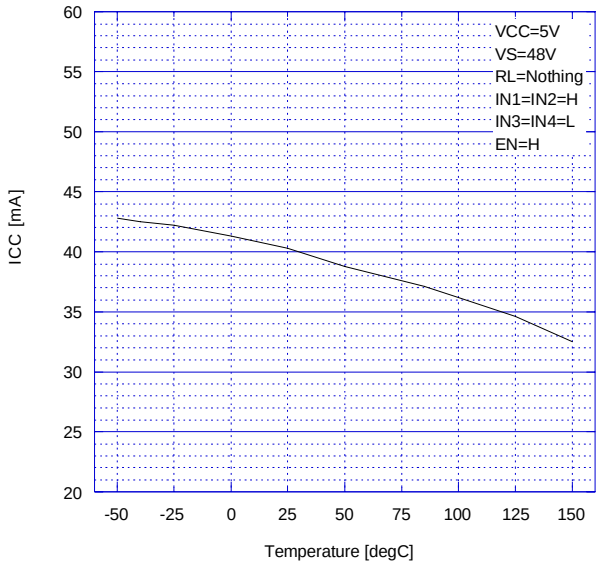
Diode(D) vs. Io



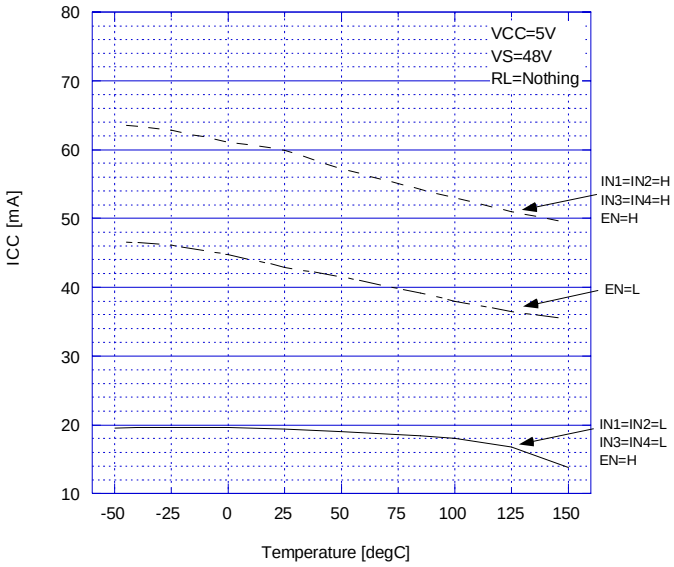
Diode(U) vs. Io



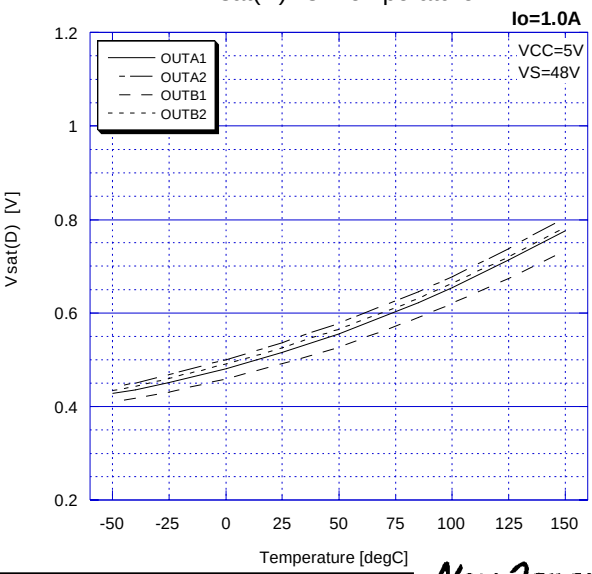
ICC vs. Temperature



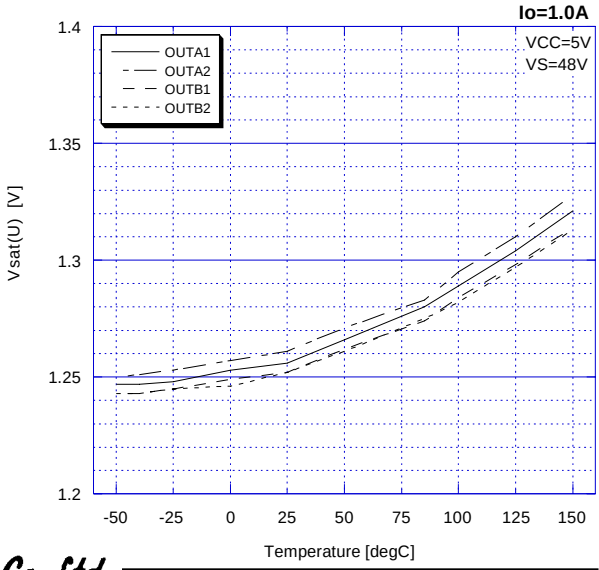
ICC vs. Temperature



Vsat(D) vs. Temperature

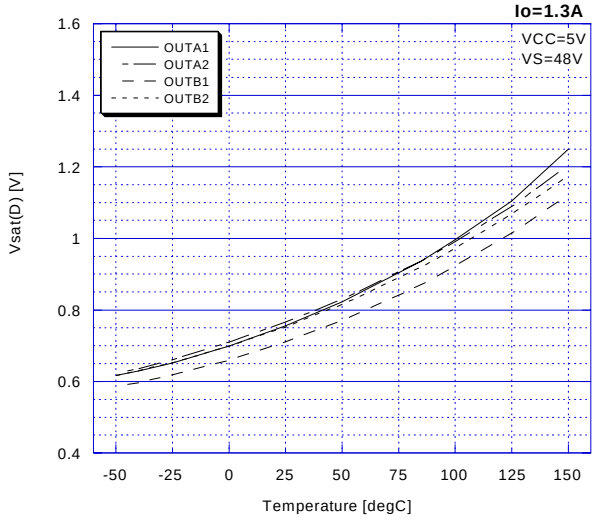


Vsat(U) vs. Temperature

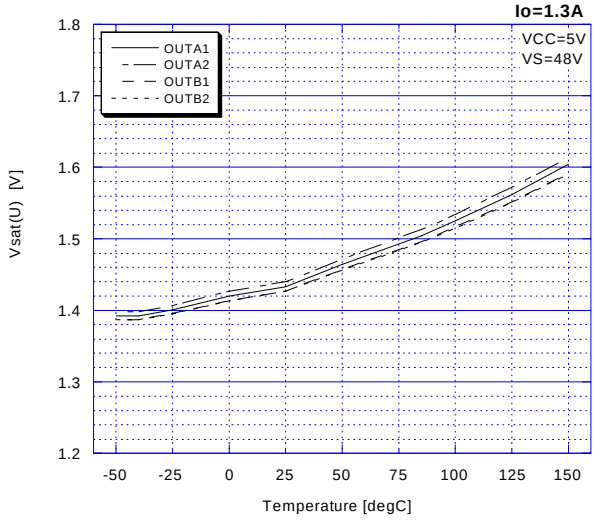


■TYPICAL APPLICATION 3

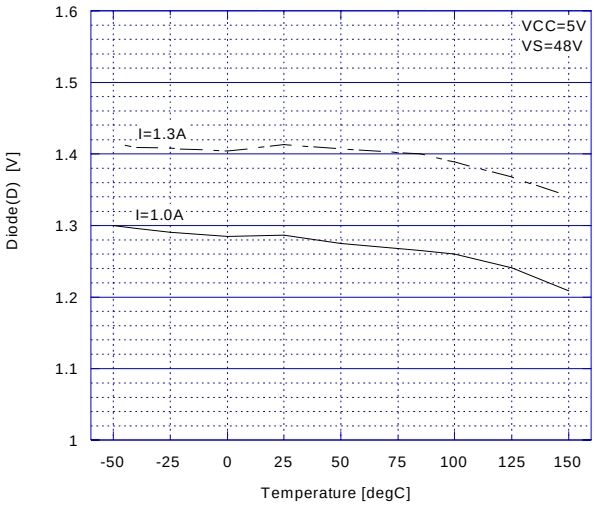
Vsat(D) vs. Temperature



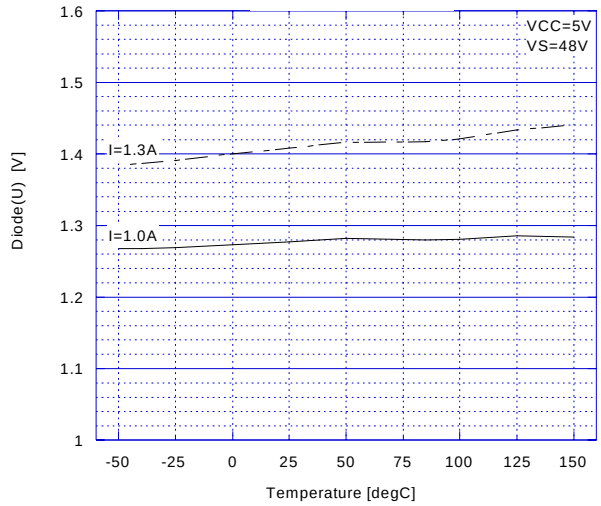
Vsat(U) vs. Temperature



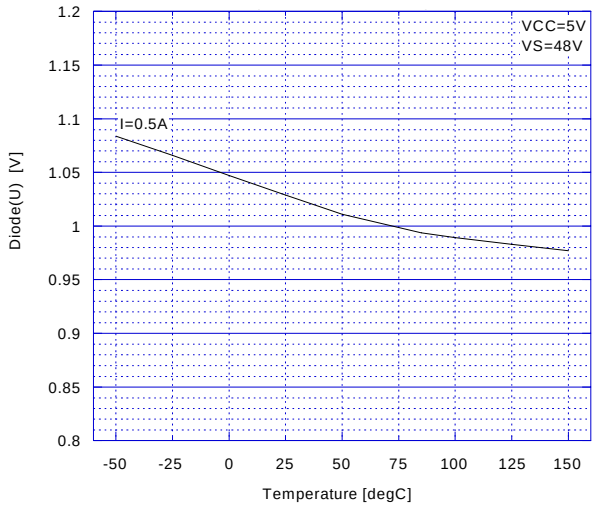
Diode(D) vs. Temperature



Diode(U) vs. Temperature



Diode(U) vs. Temperature



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